

NPN Darlington Transistor PZTA29

Description

This device is designed for applications requiring extremely high current gain at collector currents to 500 mA. Sourced from process 03.

Features

• These are Pb-Free Devices

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) (Note 1, Note 2)

Symbol	Parameter	Value	Unit	
V _{CES}	Collector–Emitter Voltage	100	V	
V _{CBO}	Collector-Base Voltage	100	V	
V _{EBO}	Emitter-Base Voltage	12	V	
I _C	Collector Current – Continuous	800	mA	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to + 150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. These ratings are based on a maximum junction temperature of 150°C.
- These are steady-state limits. onsemi should be consulted on application involving pulsed or low duty cycle operations.

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Max	Unit
P_{D}	Total Device Dissipation	1000	mW
	Derate Above 25°C	8.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

 Device mounted on FR-4 PCB 36 mm x 18 mm x 1.5 mm; mounting pad for the collector lead minimum 6cm².

MARKING DIAGRAM AYW A29 SOT-223 CASE 318H

A = Assembly Location YW = Date Code

A29 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
PZTA29	SOT-223	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PZTA29

ELECTRICAL CHARACTERISTICS (Note 4) ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Max	Unit
FF CHARAC	CTERISTICS	•			
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_C = 100 \mu A, V_{BE} = 0$	100		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu\text{A}, I_E = 0$	100		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	12		V
I _{CBO}	Collector Cut-Off Current	V _{CB} = 80 V, I _E = 0		100	nA
I _{CES}	Collector Cut-Off Current	V _{CE} = 80 V, V _{BE} = 0		500	nA
I _{EBO}	Emitter Cut-Off Current	V _{EB} = 10 V, I _C = 0		100	nA
N CHARAC	TERISTICS				
h _{FE}	DC Current Gain	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10,000		
		$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10,000		
V _{CE} (sat)	Collector–Emitter Saturation Voltage	I _C = 10 mA, I _B = 0.01 mA		1.2	V
		$I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$		1.5	
V _{BE(on)}	Base–Emitter On Voltage	$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$		2.0	V
MALL SIGN	AL CHARACTERISTICS				
f _T	Current Gain Bandwidth Product	$I_C = 15 \text{ mA}, V_{CE} = 5.0 \text{ V}, f = 100 \text{ MHz}$	125		MH
C _{obo}	Output Capacitance	V _{CB} = 1.0 V, I _E = 0, f = 1.0 MHz		8.0	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{4.} Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2.0%.

SCALE 2:1



A

В

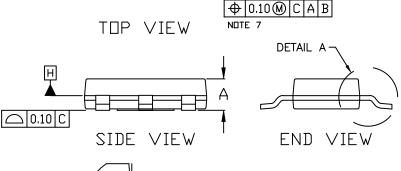
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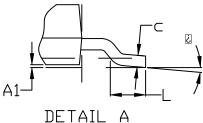
NOTES

- DIMENSIONING AND TOLERANCING PER ASME
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 Y14.5M, 2009.
 CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D & E1 ARE DETERMINED AT DATUM
 H. DIMENSIONS DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS DR GATE BURRS. SHALL NOT
 EXCEED 0.23mm PER SIDE.
 LEAD DIMENSIONS & AND &1 DO NOT INCLUDE
 DAMBAR PROTRUSION. ALLOWABLE DAMBBAR
 PROTRUSION IS 0.08mm PER SIDE.
 DATUMS A AND B ARE DETERMINED AT DATUM H.
 A1 IS DEFINED AS THE VERTICAL DISTANCE
 FROM THE SEATING PLANE TO THE LOWEST
 POINT OF THE PACKAGE BODY.
 POSITIONAL TOLERANCE APPLIES TO DIMENSIONS
 & AND &1.

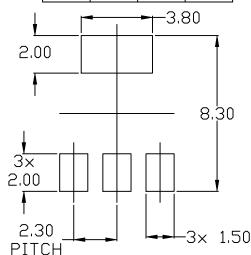
- b AND b1.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α			1.80	
A1	0.02	0.06	0.11	
b	0.60	0.74	0.88	
b1	2.90	3.00	3.10	
С	0.24		0.35	
D	6.30	6.50	6.70	
E	6.70	7.00	7.30	
E1	3.30	3.50	3.70	
е	2.30 BSC			
L	0.25			
Ż	0*		10°	









GENERIC MARKING DIAGRAM*

AYW

XXXXX.

= Assembly Location

= Year = Work Week W

XXXXX = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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